

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT3804190

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YARU SHI	03/14/2016
ANTONY P. CHACKO	03/14/2016
HONG ZHANG	03/21/2016
QINGPING CHEN	03/14/2016
RANDOLPH S. HAHN	03/16/2016
LEI XU	03/14/2016
YANG JIN	03/14/2016
ZHEN WU	03/14/2016
RECEIVING PARTY DATA	
Name:	KEMET ELECTRONICS CORPORATION
Street Address:	2835 KEMET WAY
City:	SIMPSONVILLE
State/Country:	SOUTH CAROLINA
Postal Code:	29681
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15083381
CORRESPONDENCE DATA	
Fax Number:	(866)365-3840
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	864-908-3900
Email:	jperkins@johnperkinslaw.com
Correspondent Name:	PERKINS LAW FIRM LLC
Address Line 1:	200 N MAIN ST, STE. 301
Address Line 4:	GREENVILLE, SOUTH CAROLINA 29601
ATTORNEY DOCKET NUMBER:	16066.AL.042.3
NAME OF SUBMITTER:	JOSEPH T. GUY
SIGNATURE:	/Joseph T. Guy/

DATE SIGNED:	03/29/2016
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Total Attachments: 4

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Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
16066.AL.042.3

This is an Assignment of the following rights, title and interest: (check all that apply):

- United States of America rights, title and interest in the invention
- Foreign rights, title and interest in the invention
- United States Patent Application Serial No. _____
Date of Execution: _____ Date of Filing: _____
- United States Provisional Patent Application Serial No. _____
- United States Patent No(s). _____
- International (PCT) Patent Application Serial No. _____
- Other (specify) _____

Title of the Invention

A PROCESS TO IMPROVE COVERAGE AND ELECTRICAL PERFORMANCE OF SOLID
ELECTROLYTIC CAPACITORS

Inventors (assignors)

Name	Address
Yaru Shi	KEMET Electronics Corporation 2835 KEMET Way, Simpsonville, SC 29681
Antony P. Chacko	KEMET Electronics Corporation 2835 Kemet Way, Simpsonville, SC 29681
Hong Zhang	KEMET Electronics (Suzhou) Co., Ltd., No. 99, Yang Pu Road, SIP Suzhou, Jiangsu, 215024, P. R. China
Qingping Chen	KEMET Electronics Corporation 2835 KEMET Way, Simpsonville, SC 29681
Randolph S. Hahn	KEMET Electronics Corporation 2835 KEMET Way, Simpsonville, SC 29681
Lei Xu	KEMET Electronics (Suzhou) Co., Ltd., No. 99, Yang Pu Road, SIP Suzhou, Jiangsu, 215024, P. R. China
Yang Jin	KEMET Electronics (Suzhou) Co., Ltd., No. 99, Yang Pu Road, SIP Suzhou, Jiangsu, 215024, P. R. China
Zhen Wu	KEMET Electronics (Suzhou) Co., Ltd., No. 99, Yang Pu Road, SIP Suzhou, Jiangsu, 215024, P. R. China

Assignee

Name	Address
KEMET Electronics Corporation 2835 Kemet Way Simpsonville SC 29681	

PATENT

REEL: 038119 FRAME: 0786

Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
16066.AL.042.3

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

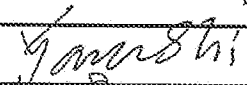
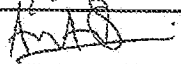
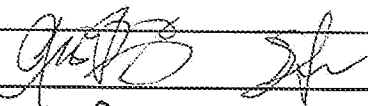
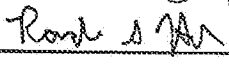
Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and an Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and an reissues and reexaminations thereof, and in and to any and an priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent, which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute any necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures

Name	Signature / Date
Yaru Shi	
Antony P. Chacko	
Hong Zhang	
Qingping Chen	
Randolph S. Hahn	 3/16/16
Lei Xu	
Yang Jin	
Zhen Wu	

PATENT

REEL: 038119 FRAME: 0787

Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
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Name	Signature / Date
Yaru Shi	
Antony P. Chacko	
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Randolph S. Hahn	
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Name	Signature / Date
Yaru Shi	
Antony P. Chacko	
Hong Zhang	
Qingping Chen	
Randolph S. Hahn	
Lei Xu	<i>Lei Xu 2016.3.14</i>
Yang Jin	<i>Yang Jin / 2016/3/14</i>
Zhen Wu	<i>Zhen Wu 3/14/2016</i>